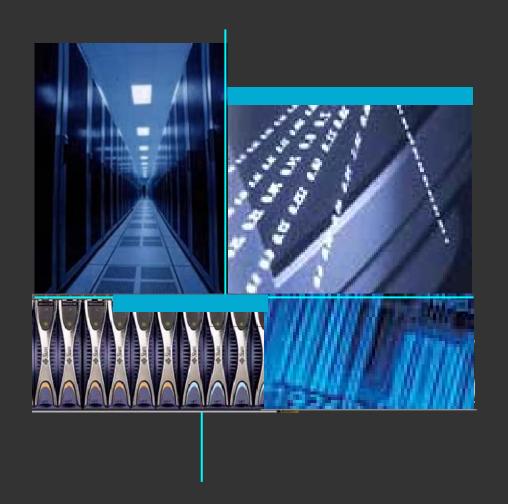
An Industry Report Modular Computing Series 2006



Architecting Next Generation Data Centers

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